

Passive Liquid Cooling enables a carbon free 350kW Modular Data Centre

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What is **OCP**?

The Open Compute Project Foundation is a non profit open source hardware community which since its formation in 2011 has been disrupting the 20th Century Data Century Industry

www.opencompute.org



Technology Contribution Process



Member makes a contribution

Including technical documents

Reviewed by community

Voted by incubation committee

Posted on opencompute.org

Available to the public





OCP Technology Principles



Efficiency - performance, cost, conversion & cooling



Scale out - Tool-less design, OCP compliant management tools and documentation



Openness - Open Source, Open Interface, OCP Compatible



Impact - Efficiency gains, new technology, leverage/empower prior contributions and enhance supply chain





Modular Data Center Air cooled 90kW







12 racks / 250 servers



Module with UPS





In-row DX cooling

3. Cooling





In-row DX cooling







In-row DX cooling





	Condenser	In-row	Servers	UPS	Total
kW	4	45	90	5	144
Hours	8760	8760	8760	8760	
MWh	30	347	788	41	1206

 $PUE = \frac{\text{Total energy}}{\text{IT energy}} = \frac{1206}{788} = 1.53$



Passive liquid cooled Modular Data Center







Passive liquid cooled OCP servers





What is the server energy?







What is the server energy?

10% of server energy



90% of server energy

CPU 70%

Memory 10%

Storage 5%

Other 5%













Is it possible to reduce the server energy?







Fans power reduction of 70%





Replacement of the heat sink with the interface



Fans power reduction of 70%

10% of server energy



3% of server energy (by reducing quantity or RPM)





Twice as dense

OCP Leopard servers



OCP Leopard servers with LHP







Twice as dense

Open Rack V2 (45 servers)



Open Rack V2 with passive liquid cooling (84 servers)





12 racks / 1000 servers (Air 250 serves)







Cool aisle temperature with air cooled CPU

Table 15. Maximum continuous operating temperature for dual processor with 2.5-inch direct / 2.5-inch NVMe drive configuration - Air cooled

CPU	TDP	Cores	24 x drives	16 x drives	8 x drives	4 x drives	No BP
7513	200	32	20	20	25	25	30
7443	200	24	20	20	25	25	30
7413	180	24	20	20	25	25	30 (-2)
7313	155	16	25	25	25	25	30
7662	225	64	Not supported	Not supported	Not supported	Not supported	20
7713	225	64	Not supported	Not supported	Not supported	Not supported	20
7543	225	32	Not supported	Not supported	Not supported	Not supported	20
7763	280	64	Not supported	Not supported	Not supported	Not supported	Not supported
7H12	280	64	Not supported	Not supported	Not supported	Not supported	Not supported

Table 17. Maximum continuous operating temperature for dual processor with 2.5-inch direct / 2.5-inch NVMe drive configuration - Liquid cooled

CPU	TDP	Cores	24 x drives	16 x drives	8 x drives	4 x drives	No BP
7513	200	32	35	35	35	35	35
7443	200	24	35	35	35	35	35
7413	180	24	35	35	35	35	35
7313	155	16	35	35	35	35	35
7662	225	64	35	35	35	35	35
7713	225	64	35	35	35	35	35
7543	225	32	35	35	35	35	35
7763	280	64	35	35	35	35	35
7H12	280	64	35	35	35	35	35
7742	225	64	35	35	35	35	35
7642	225	48	35	35	35	35	35
7542	225	32	35	35	35	35	35



4 flexible heat reuse schemes

with water cooled chiller



with adiabatic cooler (2 circuits)



with air cooled chiller



with adiabatic cooler (1 circuit)





Passive liquid cooling Rack Thermal Аіг Air for Manifolds cooler servers 1 kW 30°C 13 kW Ambient air 27°C -18...+34°C 42°C 85 kW 35°C 58°C 250 kW 335 kW



Passive liquid cooling

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Adiabatic	Duran	Аіг	C	Tabal

	Adiabatic cooler	Pumps	Air cooler	Servers	UPS	Total
kW	13	4	1	335	17	369
Hours	8760	8760	8760	8760	8760	
MWh	32	34	6	2935	149	3 155

$$PUE = \frac{\text{Total energy}}{\text{IT energy}} = \frac{3155}{2935} = 1.08$$

TCO Comparison







	Air	Passive Liquid	Savings, %
Servers	1000	1000	-
Racks	48	12	-75%
IT-load	360 kW	335 kW	-7%
Total power	576 kW	369 kW	-36%
Cooling energy	1508 MWh	72 MWh	-95%
Total energy	4836 MWh	3155 MWh	-35%
TCO, k€/3 years	3682k€	2497k€	-34%



Loop Heat Pipes (LHP) based Passive Liquid Cooling system



- Passive liquid cooling system
 - No moving parts, valves or pumps
 - No energy or water spending
- Direct-to-chip cold plate cooling
 - Simple installation / removal
 - High efficiency: up to 1kW chips
- Maximum tolerance to:
 - Gravity field and distance
 - Multiple bending for any server topology
- No risk of leakage of any kind
 - Capillary structure + negative internal pressure
- No maintenance needed. Up to 20-year lifetime.

How does it work?





- Runs as Dry Cooler as long as possible
- When needed, air is cooled in the closed adiabatic chamber before reaching the heat exchanger coil
- Closed loop cooling system with moisture absorbent material honeycomb interior
- Reduces water consumption and energy use
- Highly adaptable to different applications / climates



Thank You and visit us at booth D320





www.thermocon-lhp.com

